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H8SX Family

Using the Average Transfer Rate Generator in Transmission and Reception via the SCI (Serial Communications Interface): Polling Volume

Introduction

In the H8SX/1653, an average transfer rate generator can be selected as the clock source for serial communications interfaces 5 and 6 (SCI_5 and 6) in the asynchronous mode. In this sample task, the average transfer rate generator is used to drive the transfer of data at a rate of 921.569 kbps in operation at $P\phi = 16$ MHz.

Target Device

H8SX/1653

Contents

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1. Specifications

An average transfer rate generator can be selected as the clock source in the asynchronous mode on SCI_5 and 6 of the H8SX/1653. In this sample task, data are transmitted and received at a rate of 921.569 kbps by using the average transfer rate generator of SCI_5 with the peripheral clock running at 16 MHz.

- Connect the H8SX/1653 as shown in figure 1.
- Table 1 shows the communications format.
- In this sample task, software control by polling is applied to the reception and transmission of single bytes.

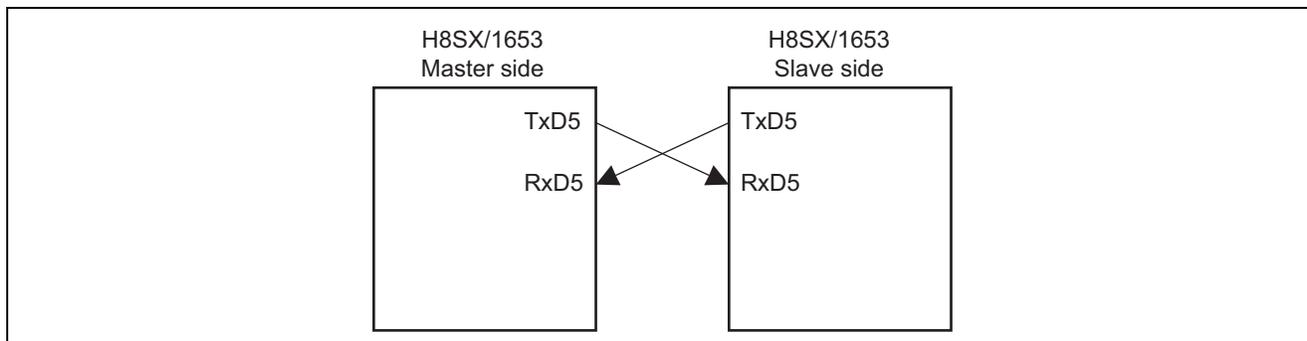


Figure 1 Setup for Asynchronous Communications with Timing from the Average Transfer Rate Generator

Table 1 Settings for Asynchronous Serial Transmission and Reception

Item	Setting
Pφ	16 MHz
Serial communications mode	Asynchronous
Clock source	Average transfer rate generator
Transfer rate	921.569 kbps
Data length	8 bits
Parity bit	None
Stop bit	1 bit
Format for serial/parallel conversion	LSB first

2. Applicable Conditions

Table 2 Applicable Conditions

Item	Description
Operating frequency	Input clock: 16 MHz System clock (I ϕ): 16 MHz Peripheral module clock (P ϕ): 16 MHz External bus clock (B ϕ): 16 MHz
Operating mode	Mode 6 (MD2 = 1, MD1 = 1, MD0 = 0) MD_CLK = 0
Development tool	High-performance Embedded Workshop Ver. 4.00.02
C/C++ compiler	Renesas Technology Corp. H8S, H8/300 Series C/C++ Compiler Ver. 6.01.00
Compiler options	-cpu = h8sxa:24:md, -code = machinecode, -optimize = 1, -regparam = 3, -speed = (register, shift, struct, expression)

Table 3 Section Settings

Address	Section Name	Description
H'001000	P	Program area

3. Description of Modules Used

3.1 SCI_5

In this sample task, SCI_5 is used for asynchronous serial data transmission. Figure 2 is a block diagram of SCI_5, and the following is a description of the functions in the diagram.

- **On-Chip Peripheral Clock P ϕ**
 This is the base clock for the operation of on-chip peripheral functions and is generated by a clock oscillator.
- **Receive Shift Register (RSR_5)**
 This register is used to receive serial data. Serial data on RSR_5 are input via the RxD5 pin. When one frame of data has been received, the data bits are automatically transferred to the Receive Data Register (RDR_5). RSR_5 is not accessible by the CPU.
- **Receive Data Register (RDR_5)**
 Received data are stored in this 8-bit register. After RSR_5 has received one frame, the data bits are automatically transferred from RSR_5 to RDR_5. Since RSR_5 and RDR_5 function as a double buffer, continuous reception is possible. RDR_5 is for reception only, and so is seen as a read-only register to the CPU.
- **Transmit Shift Register (TSR_5)**
 This register is used to transmit serial data. In transmission, data are transferred from the Transmit Data Register (TDR_5) to TSR_5, and then output on the TxD5 pin. TSR_5 is not directly accessible from the CPU.
- **Transmit Data Register (TDR_5)**
 Data for transmission are stored in this 8-bit register. The SCI_5 detects that TSR_5 is empty, data that have been written to TDR_5 are automatically transferred to TSR_5. Since TDR_5 and TSR_5 function as a double buffer, if the next byte is written to TDR_5 before transmission of the frame including the byte currently in TSR_5 is complete, the byte can be transferred to TSR_5 immediately on completion of the transmission. This allows continual transmission. Although TDR can be read from or written to by the CPU at all times, only write data for transmission data after having confirmed setting of the TDRE bit in the Serial Status Register (SSR_5) to 1.
- **Serial Mode Register (SMR_5)**
 This 8-bit register is used to select the format of serial data communications and the clock source for the on-chip baud-rate generator.
- **Serial Control Register (SCR_5)**
 This register is used to control transmission, reception, and interrupts, and to select the clock source for transmission and reception.
- **Serial Status Register (SSR_5)**
 This register consists of status flags for SCI_5 and multiprocessor bits for transmission and reception. TDRE, RDRF, ORER, PER, and FER can only be cleared.
- **Smart Card Mode Register (SCMR_5)**
 This register is used to select the smart-card or normal interface mode for SCMR_5, and to set up the format for the smart-card mode. For this task, the setting in SCMR_5 selects the normal asynchronous or clock synchronous mode.
- **Serial Extended Mode Register (SEMR_5)**
 SEMR_5 and SEMR_6 are used to select the clock source for SCI_5 and SCI_6 in the asynchronous mode. The basic (peripheral) clock is automatically specified when average transfer rate operation is selected. TMO output from timer units 2 and 3 can also be set as the base clock for serial transfer. Otherwise, specific average transfer rates are selectable according to whether the peripheral-clock frequency is 8, 10.667, 12, 16, 24, or 32 MHz. Table 4 shows the relationship between P ϕ and average transfer rate.

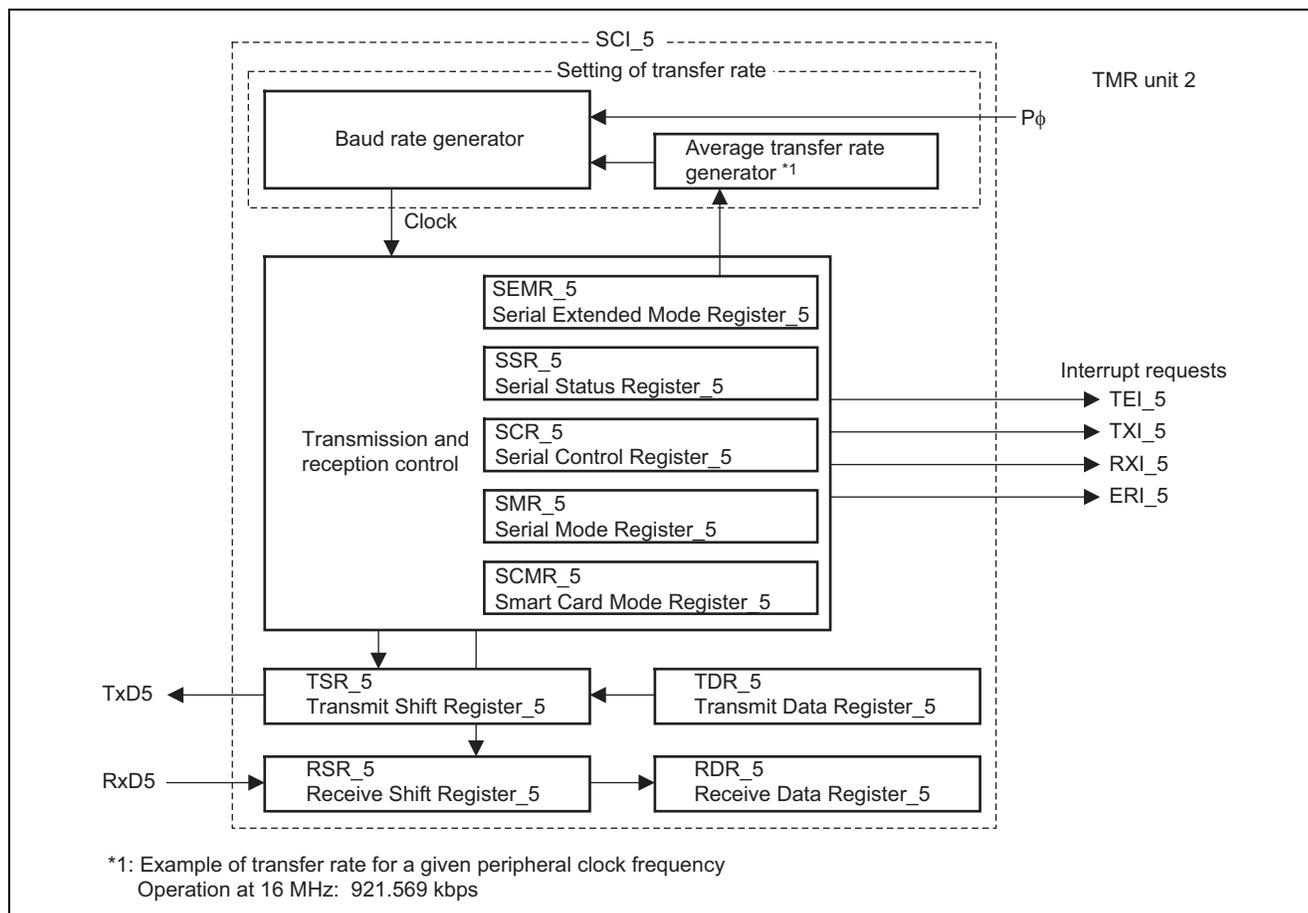


Figure 2 Block Diagram of SCI_5

Table 4 Transfer Rates of Average Transfer Rate Generators on SCI_5 and 6

Pφ (MHz)	Average Transfer Rate (kbps)
8	460.784
10.667	115.152
	460.606
12	230.263
	460.526
16	115.196
	460.784
	720 921.569
24	115.132
	460.526
	720 921.053
32	720

4. Description of Operation

4.1 Outline

Figure 3 shows the operation of this task in outline. When one byte of data is transmitted from the master side to the slave side, the same byte of data is returned from the slave side to the master side.

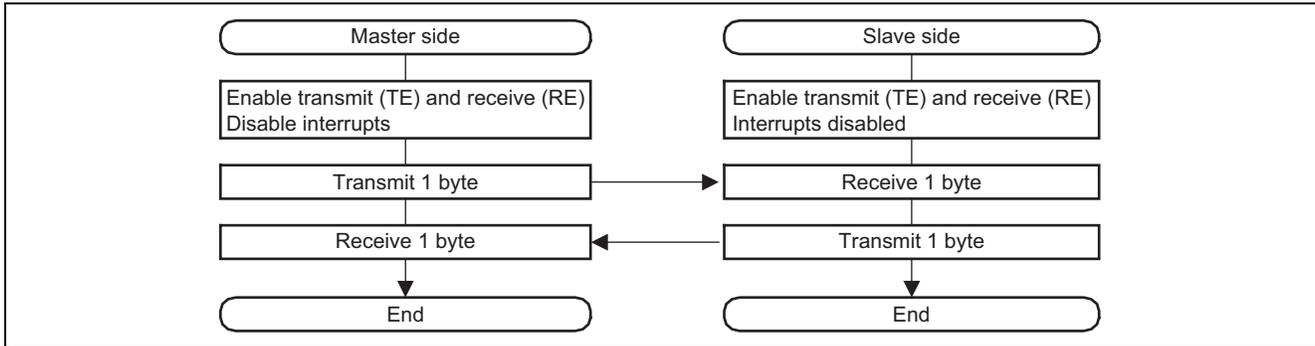


Figure 3 Outline of Operation

4.2 Example of Internal Base Clock When Pφ = 16 MHz and ACS3 to 0 = B'0011

Figure 4 shows an example of the internal base clock when Pφ = 16 MHz and ACS3 to ACS0 = B'0011. When Pφ = 16 MHz and ACS3 to 0 = B'0011, Pφ is divided by two and the cycle retention rate is 47/51. The following is the average transfer rate calculated from Pφ and the cycle retention rate.

$$\text{Average transfer rate} = \frac{\text{Base clock frequency for average-rate transfer}}{8} = \frac{\frac{P\phi}{2} \times \frac{47}{51}}{8} = \frac{7.3725 \text{ MHz}}{8} = 921.569 \text{ kbps}$$

4.3 One-Bit Period for Communications Data

The one-bit period corresponds to eight cycles of the internally generated base clock, but the actual period will differ according to whether or not a cycle of the frequency-divided peripheral clock has been omitted from the internal base clock. Therefore, the 1-bit interval is either of the following.

$$\text{Higher period for one bit: } \frac{1}{P\phi/2} \times 9 \text{ frequency-divided peripheral clock cycles} = 1.125 \mu\text{s}$$

$$\text{Lower period for one bit: } \frac{1}{P\phi/2} \times 8 \text{ frequency-divided peripheral clock cycles} = 1.0 \mu\text{s}$$

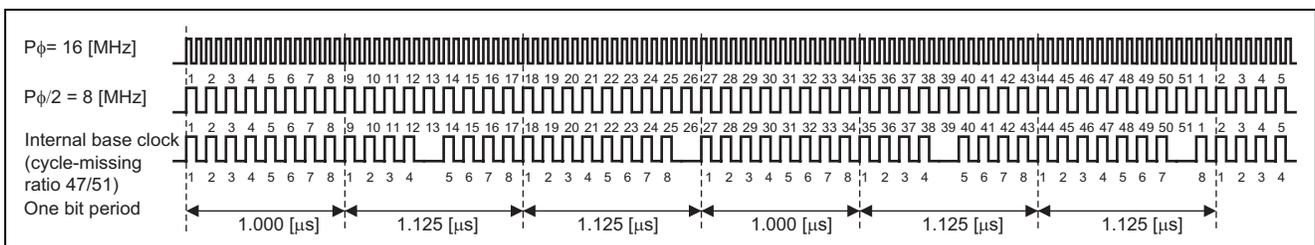


Figure 4 Example of Internal-Base-Clock Generation When Pφ = 16 MHz and ACS3 to 0 = B'0011

5. Description of Software

5.1 List of Functions

The functions of this task are shown in table 5. Figure 5 shows the hierarchical structure of this sample task.

Table 5 List of Functions

Function Name	Responsibilities
init	Initialization routine Takes the module out of module stop mode, performs clock settings, and calls the main function
main	Main routine Makes initial SCI settings for communications at a transfer rate of 921.569 kbps when operating at $P\phi = 16$ MHz

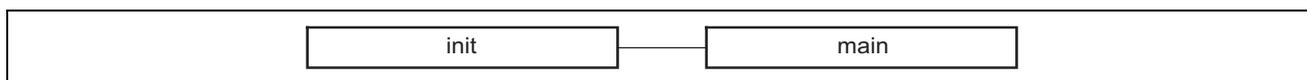


Figure 5 Hierarchy Structure

5.2 Vector Table

Table 6 Exception Handling Vector Table

Exception Handling Source	Vector Number	Vector Table Address	Vector Table Address Handling Function
Reset	0	H'000000	init

5.3 Defined Macros

Table 7 Defined Macros

Identifier	Description	Used In
MASTER	If this is defined, compilation generates the master-side program.	main
SLAVE	If this is defined, compilation generates the slave-side program.	main

5.4 Description of Functions

5.4.1 init Function

1. Overview

Initialization routine. Takes the module out of module stop mode, sets the clock, and calls the main function.

2. Arguments

None

3. Return value

None

4. Description of internal register usage

Usage of internal registers in this task is described below. The given settings are those used in the task and differ from the initial settings.

• **System Clock Control Register (SCKCR) Address: H'FFFDC4**

Bit	Bit Name	Setting	R/W	Function
10	ICK2	0	R/W	System Clock ($I\phi$) Select
9	ICK1	1		Selects the frequency of the CPU, DMAC, DTC module and system clock. 010: Input clock \times 1
8	ICK0	0		
6	PCK2	0	R/W	Peripheral Module Clock ($P\phi$) Select
5	PCK1	1		Selects the frequency of peripheral module clock. 010: Input clock \times 1
4	PCK0	0		
2	BCK2	0	R/W	External Bus Clock ($B\phi$) Select
1	BCK1	1		Selects the frequency of the external bus clock. 010: Input clock \times 1
0	BCK0	0		

- Registers MSTPCRA, MSTPCRB, and MSTPCRC control the module stop mode. Setting a bit to 1 makes the corresponding module enter the module stop mode, while clearing the bit to 0 takes the module out of stop mode.

• **Module Stop Control Register A (MSTPCRA) Address: H'FFFDC8**

Bit	Bit Name	Setting	R/W	Functions
15	ACSE	0	R/W	All-Module-Clock-Stop Mode Enable Enables/disables all-module-clock-stop mode for reducing current drawn by stopping the bus controller and I/O port operations when the CPU executes the SLEEP instruction after the module stop mode has been set for all the on-chip peripheral modules controlled by MSTPCR 0: All-module-clock-stop mode disabled 1: All-module-clock-stop mode enabled
13	MSTPA13	1	R/W	DMA controller (DMAC)
12	MSTPA12	1	R/W	Data transfer controller (DTC)
9	MSTPA9	1	R/W	8-bit timer (TMR_3, TMR_2)
8	MSTPA8	1	R/W	8-bit timer (TMR_1, TMR_0)
5	MSTPA5	1	R/W	D/A converter channels 1, 0
3	MSTPA3	1	R/W	A/D converter (unit 0)
0	MSTPA0	1	R/W	16-bit timer pulse units (TPU channels 5 to 0)

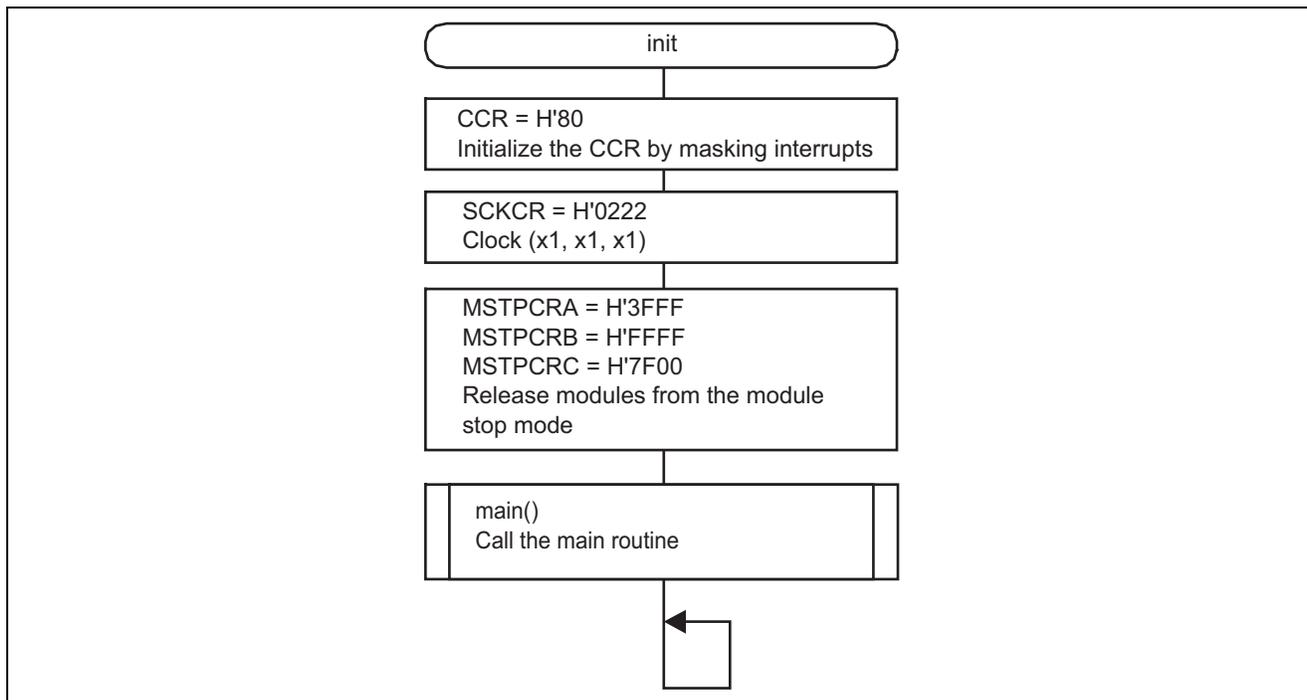
• **Module Stop Control Register B (MSTPCRB) Address: H'FFFDCA**

Bit	Bit Name	Setting	R/W	Functions
15	MSTPB15	1	R/W	Programmable pulse generator (PPG)
12	MSTPB12	1	R/W	Serial communications interface_4 (SCI_4)
10	MSTPB10	1	R/W	Serial communications interface_2 (SCI_2)
9	MSTPB9	1	R/W	Serial communications interface_1 (SCI_1)
8	MSTPB8	1	R/W	Serial communications interface_0 (SCI_0)
7	MSTPB7	1	R/W	I ² C bus interface_1 (IIC_1)
6	MSTPB6	1	R/W	I ² C bus interface_0 (IIC_0)

• **Module Stop Control Register C (MSTPCRC) Address: H'FFDCC**

Bit	Bit Name	Setting	R/W	Functions
15	MSTPC15	0	R/W	Serial communications interface_5 (SCI_5) and (IrDA)
14	MSTPC14	1	R/W	Serial communications interface_6 (SCI_6)
13	MSTPC13	1	R/W	8-bit timers (TMR_4 and TMR_5)
12	MSTPC12	1	R/W	8-bit timers (TMR_6 and TMR_7)
11	MSTPC11	1	R/W	Universal Serial Bus interface (USB)
10	MSTPC10	1	R/W	Cyclic redundancy checker
4	MSTPC4	0	R/W	On-chip RAM_4 (H'FF2000 to H'FF3FFF)
3	MSTPC3	0	R/W	On-chip RAM_3 (H'FF4000 to H'FF5FFF)
2	MSTPC2	0	R/W	On-chip RAM_2 (H'FF6000 to H'FF7FFF)
1	MSTPC1	0	R/W	On-chip RAM_1 (H'FF8000 to H'FF9FFF)
0	MSTPC0	0	R/W	On-chip RAM_0 (H'FFA000 to H'FFBFFF)

5. Flowchart



5.4.2 main Function

1. Overview

Main routine. Sets the average transfer rate in SCI and transmission/reception of one byte of data.

2. Arguments

None

3. Return value

None

4. Description of internal register usage

Usage of internal registers in this task is described below. The given settings are those used in the task and differ from the initial settings.

- **Serial Mode Register_5 (SMR_5) Address: H'FFF600**

Bit	Bit Name	Setting	R/W	Function
7	C/A	0	R/W	Communications Mode 0: Asynchronous mode 1: Clock-synchronous mode
6	CHR	0	R/W	Character Length 0: Selects 8 bits as the data length. 1: Selects 7 bits as the data length.
5	PE	0	R/W	Parity Enable 0: No parity 1: Parity
3	STOP	0	R/W	Stop Bit Length Selects the length of the stop bit for transmission. 0: 1 stop bit 1: 2 stop bits During reception, only the first bit of the stop bits is checked, and when the second bit is 0, it is regarded as the start bit of the next transmit frame.

- **Serial Control Register_5 (SCR_5) Address: H'FFF602**

Bit	Bit Name	Setting	R/W	Function
5	TE	0	R/W	Transmit Enable 0: Disables transmission 1: Enables transmission
4	RE	0	R/W	Receive Enable 0: Disables reception 1: Enables reception
1	CKE1	1	R/W	Clock Enable 1 to 0
0	CKE0	X	R/W	Selects the clock source. 00: Internal baud rate generator 1X: TMR clock input or average transfer rate generator

Legend

X: Don't care

- **Transmit Data Register_5 (TDR_5) Address: H'FFF603**

Function: This 8-bit register holds the data for transmission and is readable and writable.

Setting: Not fixed

• Serial Status Register_5 (SSR_5) Address: H'FFF604

Bit	Bit Name	Setting	R/W	Function
7	TDRE	Not fixed	R/(W)*	Transmit Data Register Empty Indicates whether TDR contains data for transmission [Setting conditions] <ul style="list-style-type: none"> • Clearing of the TE bit in SCR (to 0) • Transfer of data from TDR to TSR [Clearing conditions] <ul style="list-style-type: none"> • Writing a 0 to TDRE after having read TDRE = 1 • Generation of a TXI interrupt request allowing DMAC to write data to TDR
6	RDRF	0	R/(W)*	Receive Data Register Full Indicates whether RDR holds received data [Setting condition] <ul style="list-style-type: none"> • The normal end of serial reception and the transfer of received data from RSR to RDR [Clearing conditions] <ul style="list-style-type: none"> • Writing of 0 to RDRF after having read RDRF = 1 • Generation of an RXI interrupt request allowing DMAC or DTC to read data from RDR The RDRF flag is not affected and retains its previous value when the RE bit in SCR is cleared to 0. Note that when the next serial reception is completed while the RDRF flag is being set to 1, an overrun error occurs and the received data are lost.
5	ORER	0	R/(W)*	Overrun Error [Setting condition] <ul style="list-style-type: none"> • Occurrence of an overrun error in reception [Clearing condition] <ul style="list-style-type: none"> • Writing of 0 to ORER after reading ORER = 1
4	FER	0	R/(W)*	Framing Error [Setting condition] <ul style="list-style-type: none"> • Occurrence of a framing error in reception [Clearing condition] <ul style="list-style-type: none"> • Writing of 0 to FER after reading FER = 1
3	PER	0	R/(W)*	Parity Error [Setting condition] <ul style="list-style-type: none"> • Occurrence of a parity error in reception [Clearing condition] <ul style="list-style-type: none"> • Writing of 0 to PER after reading PER = 1
2	TEND	Not fixed	R	Transmit End [Setting conditions] <ul style="list-style-type: none"> • The TE bit in SCR being 0 • TDRE = 1 on transmission of the last bit of a character for transmission [Clearing conditions] <ul style="list-style-type: none"> • Writing of 0 to TDRE after having read TDRE = 1 • Generation of a TXI interrupt request allowing DMAC to write data to TDR

Note: * Only 0 can be written here, to clear the flag.

- **Receive Data Register_5 (RDR_5) Address: H'FFF605**

Function: This is an 8-bit register that holds received data and is read-only.

Setting: Undefined

- **Smart Card Mode Register_5 (SCMR_5) Address: H'FFF606**

Bit	Bit Name	Setting	R/W	Function
0	SMIF	0	R/W	Smart Card Interface Mode Select 0: Operation is in the normal asynchronous or clock synchronous mode 1: Operation is in the smart card interface mode

- **Serial Extended Mode Register_5 (SEMR_5) Address: H'FFF608**

Bit	Bit Name	Setting	R/W	Function
4	ABCS	0	R/W	Asynchronous Mode Basic Clock Select (valid only in the asynchronous mode) Selects the base clock for generating 1-bit periods (the transfer rate). 0: The transfer rate is 1/16 of the frequency of the base clock. 1: The transfer rate is 1/8 of the frequency for average-rate transfer.
3	ACS3	0	R/W	Asynchronous Clock Source Select
2	ACS2	0	R/W	Selects the clock source in the asynchronous mode. See table 8.
1	ACS1	1	R/W	0011: Selects average transfer rate of 921.569 kbps specifically for P ϕ = 16 MHz. Note 1: When the average transfer rate is selected, the base clock is automatically set regardless of the ABCS bit in the SEMR_5 register (asynchronous base clock selection). Note 2: The setting has the desired effect only when bits ACS3 to ACS0 are in the asynchronous mode (C/ \bar{A} bit of SMR register is 0), and the external clock input is selected (CKE1 bit of SCR register is 1).
0	ACS0	1	R/W	

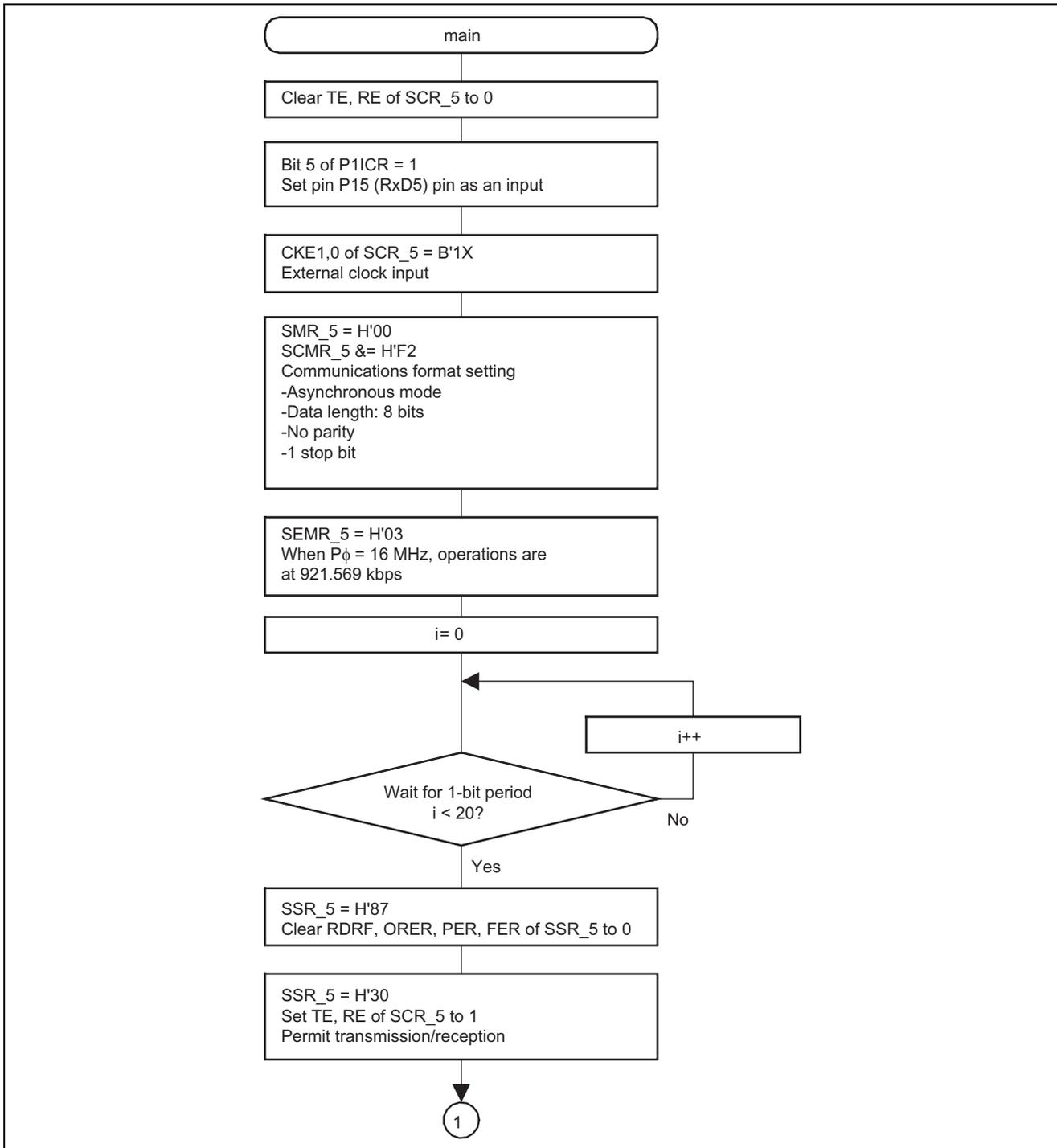
Table 8 Setting Table for Selecting Asynchronous Clock Source

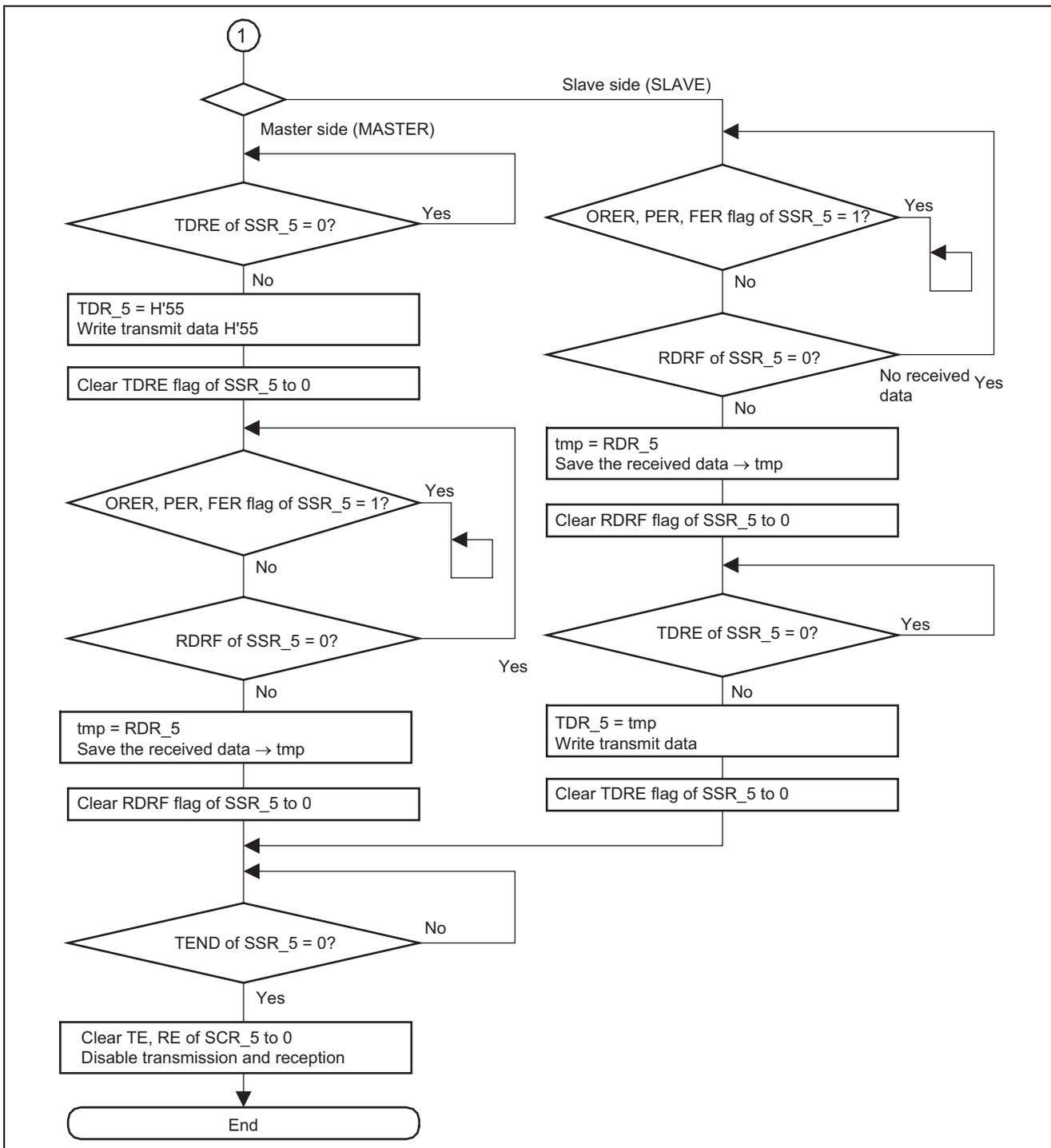
ACS3 to 0	Transfer Rate	P ϕ (MHz)	Functions
0000	(Set by the ABCS bit)	-	The average rate transfer generator is not used.
0001	1/16 th of the base clock frequency for average-rate transfer	10.667	Average transfer rate 115.152 kbps
0010	1/8 th of the base clock frequency for average-rate transfer	10.667	Average transfer rate 460.606 kbps
0011	1/8 th of the base clock frequency for average-rate transfer	16	Average transfer rate 921.569 kbps
		8	Average transfer rate 460.784 kbps
0100	(Set by the ABCS bits)	-	Selects TMR-clock input: compare-match output of TMR provides the base clock for transfer
0101	1/16 th of the base clock frequency for average-rate transfer	16	Average transfer rate 115.196 kbps
0110	1/16 th of the base clock frequency for average-rate transfer	16	Average transfer rate 460.784 kbps
0111	1/8 th of the base clock frequency for average-rate transfer	24	Average transfer rate 720 kbps
1000	1/16 th of the base clock frequency for average-rate transfer	24	Average transfer rate 115.132 kbps
1001	1/16 th of the base clock frequency for average-rate transfer	24	Average transfer rate 460.526 kbps
		12	Average transfer rate 230.263 kbps
1010	1/8 th of the base clock frequency for average-rate transfer	24	Average transfer rate 720 kbps
1011	1/8 th of the base clock frequency for average-rate transfer	24	Average transfer rate 921.053 kbps
		12	Average transfer rate 460.526 kbps
1100	1/16 th of the base clock frequency for average-rate transfer	32	Average transfer rate 720 kbps

- **Port 1 Input Buffer Control Register (PIICR) Address: H'FFFB90**

Bit	Bit Name	Setting	R/W	Function
5	P15ICR	1	R/W	0: P15 pin input buffer is disabled. Input signal is fixed to the high level. 1: P15 pin input buffer is valid. The pin state reflects the peripheral modules.

5 Flowchart





Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Mar.10.06	—	First edition issued

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